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(54) METHODS OF APPLYING A NANOCRYSTALLINE DIAMOND FILM TO A CUTTING TOOL

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(57) ABSTRACT

Methods of applying a nanocrystalline diamond film to a cutting tool are provided. In the methods, the cutting tool comprises tungsten carbide and has a cutting edge with a radius of curvature of no more than about 1 μ m. The methods can comprise seeding a cutting surface of the cutting tool with a diamond nanopowder, the cutting surface having a reduced cobalt content, and depositing a nanocrystalline diamond film having a thickness of no more than about 1 μ m onto the seeded cutting surface. The methods can also comprise implanting carbon ions into a cutting surface of the cutting tool to provide a carbide rich cutting surface and depositing a nanocrystalline diamond film having a thickness of no more than about 1 μ m onto the carbide-rich cutting surface.

18 Claims, 3 Drawing Sheets



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FIG. 2



FIG. 3



METHODS OF APPLYING A NANOCRYSTALLINE DIAMOND FILM TO A **CUTTING TOOL**

FIELD OF THE INVENTION

In general, the present invention relates to micro-cutting tools with nanocrystalline diamond coatings on their cutting surface. The invention also relates to methods for the preparation of nanocrystalline diamond-coated micro-cutting 10 tools.

BACKGROUND

There is growing interest in high-precision machining to 15 fabricate miniaturized parts for medical devices, micro-satellites, microfluidics, and the optics and electronics industries, with meso-scale machine tool systems (MMTS) which utilize tools with diameters ranging from 10 to 500 µm. Such MMTS technologies complement standard silicon micro-ma-20 chine fabrication processes with the ability to directly produce true, three-dimensional structures with high accuracy, low cost, and short cycle time. One of the key methods in MMTS technology is micro-end milling. Precision machining with micro-end milling is strongly influenced by the 25 required while machining a material with the cutting tools choice of tool materials. Tungsten carbide (WC) with cobalt binder (WC-Co) is widely used as a standard material. However, it suffers from a number of drawbacks such as limited and unpredictable operational life, rapid degradation of performance with use due to tool fatigue and wear, diffi- 30 culty in machining adhesive metals such as aluminum and copper, and poor surface finish.

To combat the drawbacks of the use of WC—Co as a tool material for MMTS technologies, one possible solution is to coat the WC-Co with harder materials such as diamond. 35 Unfortunately, conventional diamond films contain relatively large crystallites, placing a limitation on the minimum thickness of the films and making such film practical only for larger tools (e.g., tools having a diameter of 500 µm or greater). (See, for example, Jackson, et al., Proc. Instn. Mech. 40 Engrs., Vol. 217, p. 77 (2003).

Bruhne et al., have reported depositing nanocrystalline diamond films on tungsten carbide cutting tools. (See, Bruhne et al., Rev. Adv. Mater. Sci., Vol. 10, p. 224 (2005).) However, the minimum reported thickness of such films is 10 µm, which 45 the authors admit renders the tool incapable of cutting. Only by using a reactive ion etch (RIE), were the authors able to reduce the thickness of the film.

SUMMARY

The present invention provides tungsten carbide-containing surfaces, and particularly tungsten-carbide-containing cutting tools, that are at least partially coated with a thin nanocrystalline diamond (NCD) film. The films are desirably 55 continuous and uniform, with thicknesses of no greater than about 1 μ m. The films may be coated onto the cutting edge(s) of a micro-cutting tool to strengthen the tool, thereby extending its lifetime without significantly increasing the diameter or radius of curvature of the cutting surface. Cutting tools that 60 may benefit from the NCD coatings include, but are not limited to, micro-end mills, routers and drills. However, other substrates and tools may also be coated with the NCD coating to improve their performance and/or strength. Such tools include drawing dies, razor blades, and the like.

Methods for producing the NCD-coated substrates and cutting tools are also provided. In one embodiment, the

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method includes the steps of reducing the cobalt content at the surface (e.g., the cutting surface) of the substrate (e.g., the cutting tool) or coating the surface of the tool with a thin tungsten film; seeding the surface of the substrate with a diamond powder containing nano-scale (e.g., $\leq 5-10$ nm) diamond particles ("diamond nanopowder") or implanting carbon atoms into the surface of the substrate to provide a carbide-rich surface layer; and depositing the NCD coating over at least a portion of the surface. Hot filament chemical vapor deposition is a technique that may be used to deposit the NCD coatings.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic drawing of a hot filament chemical vapor deposition system used for the deposition of NCD coatings on micro-tools.

FIGS. 2(a), 2(b), and 2(c) are SEM micrographs of an NCD-coated WC micro-tool (a) as viewed from the tool's cutting edge, (b) as a magnification of the encircled region in (a) showing the microstructure of the NCD film, and (c) as a cross-section the NCD film, with the film bordered by the light lines.

FIG. 3 is a graphical illustration of the average force embodied herein.

DETAILED DESCRIPTION

The following definitions are used throughout the present disclosure:

"AES" is an abbreviation for Auger electron spectroscopy. "AFM" is an abbreviation for atomic force microscopy.

"BEN" is an abbreviation for bias enhanced nucleation.

"CVD" is an abbreviation for chemical vapor deposition.

"HFCVD" is an abbreviation for hot filament chemical vapor deposition.

"NCD" is an abbreviation for nanocrystalline diamond.

"RIE" is an abbreviation for reactive ion etching.

"RMS" is an abbreviation for root mean square.

"sccm" is an abbreviation for standard cubic centimeters per minute.

"SEM" is an abbreviation for scanning electron microscopy.

"WC" is an abbreviation for tungsten carbide.

"WC-Co" is an abbreviation for tungsten carbide with a cobalt binder.

Generally, disclosed herein are micro-cutting tools coated with an NCD thin film and methods for fabricating such tools. 50 As used herein, the term "micro-cutting tool" refers to a cutting tool having a cutting surface with a diameter of no more than about 500 µm, desirably no more than about 300 µm, more desirably no more than about 200 µm and still more desirably no more than about 100 µm. By way of illustration, the cutting surface of a micro-end mill would be the surface defined by the perimeter of cutting part of the mill, including the cutting edges extending therefrom. The cutting edges on the micro-cutting tools desirably have a radius of curvature of no more than about 2 µm, and desirably no more than about 1 um.

A first aspect of the invention provides micro-cutting tools comprising tungsten carbide and having a cutting surface and at least one cutting edge; and a hydrogen terminated NCD thin film having a thickness of no more than about 1 µm on at least a portion of the cutting surface.

NCD is a unique form of diamond that is distinguishable from other forms of diamond based on the size of the diamond crystallites in the material. As used herein, the term nanocrystalline diamond refers to a carbon material having a crystallite grain sizes of 10 to 100 nm. In contrast, microcrystalline diamond has a grain size of about 0.5 μ m or greater and ultrananocrystalline diamond has a grain size of less than 5 about 5 nm. In addition, NCD is characterized by an electronic bonding character from >5% up to 50% sp². In contrast, microcrystalline diamond is characterized by an sp³ bonding character and ultrananocrystalline diamond has only about 2-5% sp² bonding character.

The NCD films are thin films. In some embodiments, the NCD thin films have a thickness of no more than about 1 μ m. This includes embodiments where the NCD films have a thickness of no more than about 500 nm, further includes embodiments where the NCD films have a thickness of no more than about 200 nm, still further includes NCD films having a thickness of no more than about 100 nm, and even further includes NCD thin films having a thickness of no more than about 50 nm.

Because the NCD films are so thin, they minimize the 20 overall increase in the radius of curvature of the cutting edges of the coated cutting tools. For example, in some embodiments, the NCD-coated micro-cutting tools will have a radius of curvature of no more than about 2 μ m, desirably no more than about 1 μ m, more desirably no more than about 0.5 μ m 25 and still more desirably no more than about 0.1 μ m.

The NCD coatings may be applied to a variety of cutting tools that are made entirely from, are coated with, or otherwise include WC. The cutting tools are generally characterized by a cutting surface having at least one cutting edge, but 30 may have a wide range of geometries. Cutting tools embodied herein include, but are not limited to, end mills, drills, routers, saw blades, razor blades, knives, and scrapers.

A second aspect of the invention provides methods for fabricating micro-cutting tools comprising WC and having a 35 cutting surface and at least one cutting edge; and an NCD thin film having a thickness of no more than about 1 μ m on at least a portion of the cutting surface.

One basic embodiment the method includes the steps of seeding a reduced cobalt-content cutting surface of a micro- 40 cutting tool with a diamond nanopowder, and depositing an NCD film having a thickness of no more than about 1 µm onto the seeded cutting surface. The deposition step is desirably carried out using HFCVD. A "reduced cobalt content cutting surface" is a WC surface that has undergone processing to 45 remove cobalt (Co), such that the surface of the tool has a lower cobalt content that the underlying areas, or that has been coated with a tungsten film through which cobalt does not diffuse to the surface after being exposed to heat during the growth process. The reduction of the cobalt content is 50 done to improve the adhesion of the NCD to the surface of the tool. In the untreated state, the WC used to craft cutting tools typically contains about 8-10 wt % Co as a binder phase for the metal. Co interferes with the nucleation of the NCD, hindering film growth. In addition, Co is known to react with 55 carbon at temperatures used in an HFCVD apparatus. Such reaction of Co with the carbon growing the NCD catalyzes the formation of non-diamond carbon deposits, which may weaken the bonding between the NCD and WC.

The reduction of the cobalt content of the cutting surface 60 may be carried out using a chemical etch. Etching may be done to selectively remove small amounts of Co from the surface of the tool, such that the tool is not weakened and NCD deposition is not affected. The etching solution may be a mixture of HF, HNO₃, and deionized water in appropriate 65 proportions as listed in Table 2. The process of etching the end of the tool may be achieved by dipping the tool in an etching

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solution using a micro-positioner. The micro-positioner may have an accuracy of moving the tool along the z-axis to within tens of microns. Cobalt-content reduction on the surface of the tool may be measured by surface-sensitive AES techniques that can detect chemical changes on the surface of a tool, with a depth resolution of approximately 5 nm. Table 1 shows etching times and corresponding Co content as measured using AES. The strength of the etching solution and the length of time the tool is in contact with the etching solution may have an effect on the strength of the tool and the uniformity of the NCD coating on the tool. Etching times of about 3 to 10 seconds, at the strength of the etching solutions tested, appear to produce good quality NCD coatings on tool surfaces while maintaining good adhesion. Thus, etching times range from about 3 seconds to about 10 seconds in some embodiments, from about 4 seconds to about 8 seconds in other embodiments, and from about 5 seconds to about 7 seconds in yet other embodiments. SEM micrographs of unetched and etched tools reveal that the WC surface of the unetched tools is smoother than that of etched tools where the WC graining tends to be more pronounced, suggesting that Co is removed from the grain boundary regions.

TABLE 1

]	Etching measurements on micro-tool using AES				
Tool	Etching time (s)	Cobalt content (Atomic %)			
1	0	5.15			
2	3	5.13			
3	5	3.68			

The reduction of the cobalt content of the cutting surface may be carried out by coating the tool with a thin film of tungsten (e.g., thickness=30-250 nm). This tungsten film prevents cobalt from diffusing to the surface.

After the cutting surface of the micro-tool has been treated to reduce its Co content, the cutting surface is desirably seeded with diamond powder comprising nanoscale diamond particles in order to promote adhesion of the subsequently deposited NCD film. The diamond powder desirably has an average particle size of no greater than about 10, or even 5 nm. Seeding may be accomplished by polishing the surface with diamond powder or by using an ultrasonic treatment in an alcohol solution containing the diamond powder. Agglomerations of diamond particles may be reduced by rinsing the tool repeatedly in alcohol solution after the ultrasonication process. A comparison of SEM images of: (a) a micro-end mill after an ultrasonic nucleation process without any rinsing and (b) a micro-end mill after an ultrasonic nucleation process after multiple rinsing cycles demonstrated that agglomeration was greatly reduced using the rinsing treatment. Failure to limit the agglomerations may cause uneven nucleation of the diamond during the diamond growth. Thus, in another embodiment, methods are provided comprising rinsing a tool after sonicating, but prior to NCD deposition.

Another method of improving the adhesion of the NCD film to the cutting surface is to implant carbon ions into the cutting surface prior to NCD deposition. This carbon implantation results in a carbide-rich surface layer which enhances NCD nucleation. BEN may be used for carbon ion implantation to provide nucleation sites for the growth of NCD thin films. BEN may be carried out by applying a DC bias voltage of about 100-200 volts to the substrate, with respect to the filament, in the presence of a methane gas at high concentration. Using this process, well-bonded, conformal NCD coatings with thicknesses of about 100 nm, or lower, may be

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achieved. Such processes are not limited to tools, but may also be used in a variety of other applications such as in the coating of wire drawing dies, razor blade manufacturing, and other processes where the size and shape of a tool to be coated with NCD is not readily conducive to polishing or sonication 5 methods

Once the micro-tools have been appropriately pre-treated, the NCD films may be formed. As introduced above, microtools embodied herein may be coated with NCD films in an HFCVD apparatus as shown in FIG. 1. FIG. 1 is a schematic 10 depiction of a HFCVD system 10 used in the present methods to coat micro tools with an NCD thin film. The HFCVD system 10 consists of a heated filament 140 which is heated to a predetermined temperature using resistive heating from electrical source 110. Precursor gas and hydrogen, in a speci-15 fied mixing ratio, are introduced to the chamber 100 through inlet 120 and passed over the hot filament 140. The heated substrate (i.e., tool, or item to be coated) 150 is placed on stage 160, in proximity to the heated filament 140. Once the precursor gas and hydrogen have been spent and become off 20 gases, the off gases are exited from the chamber 100 through outlet 130. Ar gas may also be added to the mixture of precursor gas and hydrogen gas. The use of Ar gas in the mixture (e.g., about 5 to 10 volume percent) results in the formation of NCD films with a higher sp³ content. For example, using a 25 volume percent of 5% and 10% in a methane/hydrogen mixture resulted in the formation of NCD films having an sp³ content of 97.1% and 96.7% (as measured by XANES spectroscopy), respectively.

In some embodiments, the temperature of the heated fila- 30 ment 140 is from about 1800° C. to about 2400° C., or from about 2000° C. to about 2200° C., in other embodiments. The temperature at which the heated filament 140 is operated may be dependent upon a number of factors, including the substrate, the precursor gas, and the mixing ratio of precursor gas 35 to hydrogen. The temperature of the filament causes dissociation of H₂ into atomic hydrogen (H°) while CH₄ dissociates to form hydrocarbon radicals, such as C₂H₂* or CH₃*. The liberated gaseous species then migrate toward the heated substrate 150, a few millimeters from the filament. The heated 40 substrate is maintained at a temperature of about 700° C. to about 1200° C. in some embodiments, from about 800° C. to about 1100° C. in other embodiments, and from about 850° C. to about 900° C. in yet other embodiments. Under appropriate conditions of filament and substrate temperatures, gas ratios, 45 and chamber pressure, an NCD film is formed on the tool surface. Suitable precursor gases include, but are not limited to, methane, ethane, propane, butane, iso-butane, tert-butane, pentane, iso-pentane, neo-pentane, or mixtures of any two or more thereof. Mixing ratios of precursor gas to hydrogen 50 range from about 0.1 to about 10 vol. % in some embodiments, from about 2 to about 8 vol. % in other embodiments, and from about 3 to about 6 vol. % in yet other embodiments.

The filament temperature and WC tool temperature during the NCD growth may be monitored using an optical pyrom- 55 eter. Alternatively, the temperature could be measured by a thermocouple embedded in the sample holder. Typical growth parameters to deposit thin, conformal NCD films on the WC micro-tools are shown in Table 2.

thin NCD films are distinguishable from films made by other processes. For example, diamond films, in which oxygen is used for reactive ion etching, have an oxidized surface that is susceptible to reaction with metal surfaces. Conversely, the presence of hydrogen in the CVD reactor results in hydrogen-65 terminated diamond films that are more robust and less chemically reactive than their oxidized counterparts. The

resulting NCD films are distinguishable from films that have been thinned by an RIE process, since the latter are not hydrogen-terminated and have a graphitic or amorphous soot formed at their etched surfaces. The present NCD film surfaces are free of this soot and are desirably free of oxygen. The term "continuous" indicates that the coating is not broken or splotchy, such that areas of one are desirably also free of oxygen and the underlying tool substrates are exposed through the film. The uniformity of the NCD films may be characterized by their RMS roughness.

EXAMPLES

Materials: The tools used for the NCD coatings were made from WC containing greater than 8% Co. Tools were purchased from Performance Micro Tool, Inc (Janesville, Wis.). The tool tip diameter was approximately 300 µm with a stub length of approximately 600 µm. All new tools were first inspected with an SEM and sorted out for any defects. Broken tools were discarded. The tools were inspected after each step to determine if any tools were broken at various steps.

Micro-Tool Coating and Characterization: Diamond powder nucleated WC micro-end mills were coated with NCD using HFCVD methods as shown in FIG. 1. In this example, the tungsten filament of the HFCVD apparatus was heated to a temperature of approximately 2200° C. A mixture of precursor methane and hydrogen gas, with a methane percentage of 3-6 vol. %, was passed over the heated filament. The heated substrate (i.e., the cutting edge of the end mill) was maintained at a temperature of approximately 850-900° C., as determined by optical pyrometry. Growth parameters used to deposit thin, conformal NCD films on the WC micro-end mills are shown in Table 2. Films grown by this method are very uniform, even at average film thicknesses of approximately 160 nm.

TABLE 2

Nominal NCD co	ating grov	vth conditions
Etching		
Acid composition		
50% HF	10	ml
HNO ₃	20	ml
H ₂ O (De-ionized)	20	ml
Acid Etching Time	5-7	sec
Seeding		
Duration of ultrasonic treatment with diamond nanopowder in	15	min
acetone		
Duration of ultrasonic cleaning	10	min
with acetone		
Growth		
Tool Position	~3.5	mm below from the filament
Methane Flow	4-6	sccm
Hydrogen Flow	94-96	sccm
Argonne Flow	5-10	scem
Chamber Pressure	30-50	
Growth time	45	min

FIG. 2 shows SEM micrographs of an NCD-coated micro-Importantly, the present continuous, uniform, conformal, 60 end mill. FIG. 2(a) is the micrograph of the cutting surface, FIG. 2(b) is a side view of a cutting edge, and FIG. 2(c) shows the cross section SEM image taken on another micro-end mill where the NCD film was deposited with a thickness of approximately 160 nm. It is noteworthy that the NCD film is still continuous and conformal at such a low film thickness. Such uniformity and continuity of thin NCD films has been heretofore unknown.

Micro-Tool Evaluation: The micro-end mills were evaluated by a machining test. The machining test used tools with and without NCD coatings. The machining process consisted of the following steps: (a) machining a channel and recording the force necessary during machining, (b) measuring the 5 depth of cut, (c) observing the surface roughness and burring. The typical conditions for the machining are given in Table 3.

TABLE 3

Workpiece material CNC Milling Machine High-speed Spindle Tool (end mill)	6061-T6 Aluminum HAAS TM-1 NSK-HES500		
Material	0.4 µm grain carbide		
Diameter	304.8 µm (0.012 in)		
Flutes	2		
Spindle Speed	40,000 rpm		
Feed Rate	250 mm/min		
Feed	6.25 μm/rev		
Chip Load	3.125 mm/tooth		
Coolant	None		
Depth of Cut	100 um		

SEM images of the uncoated and NCD-coated tools after the machining test, were recorded, as well as the corresponding optical images of the machined channel. The SEM images reveal that, after machining, the uncoated tool was covered with Al metal fragments (as confirmed by Energy Dispersive Spectroscopy (EDS) data) and had broken edges, and a significant accumulation of metal burring occurred along the 30 side of the channel. In contrast, the NCD-coated tool showed no sign of measurable wear and no sticking of Al fragments, and the machined channel was clean, with no burr formation. These results were consistent for at least three sets of uncoated and NCD-coated tools under the same testing con- 35 ditions

Images of the channel that was cut into the aluminum during the machining test reveal that the NCD-coated tools make a cleaner cut, with little or no burr formation. Roughness analysis of the channels using a 3D optical profilometer 40 revealed somewhat lower RMS roughness (200 nm) in channels machined with NCD-coated tool as opposed to 300 nm in channels machined with uncoated tools. This is not surprising, since the coated tools accumulate metal debris during machining which may cause smearing effects and weld chips 45 to the machined surface, producing a rougher morphology. However, the NCD growth parameters may also be tailored to produce NCD surfaces with smoother morphologies.

Accumulated debris on an uncoated tool may also produce chattering. Chattering occurs as the tool meets the surface that 50 is to be cut. Chatter on the surface correlates to a force spike in the data. This is where the tool has broken and chatters until it stabilizes again at a lower force.

A force dynamometer was used to measure the forces applied during machining to the workpiece along the x, y, and 55 coated with a tungsten film prior to seeding. z axes. The z axis was ignored, as the tool was used to machine horizontally. The x and y data are used to calculate the thrust (i.e., radial), F_{t} , and main cutting (i.e., tangential) F_{c} forces. This force test was done with a depth of cut of 100 µm. The feed rate was slowed to 200 mm/min for all the tools. FIG. 3 60 is a graphical illustration of F_t and F_c vs. time for the series of uncoated and coated tools. Both forces are reduced for the coated tool, but the tangential force is reduced by about 50%. The coated tool cut a deeper channel. To verify the initial data, three more tools were coated and tested against five other 65 uncoated tools. The NCD coating on all the tools was grown under the same conditions. The uncoated tools showed a force

spike at about 0.5 mm where chatter was observed when looking at the work piece. All uncoated tools showed wear, breaking of at least at one corner, and were covered in aluminum. All NCD-coated tools failed show any evidence of breaking or wearing, and had no aluminum sticking to the tool.

For the purposes of this disclosure and unless otherwise specified, "a" or "an" means "one or more." Also, for the purposes of this disclosure, the term "about" in conjunction 10 with a numerical value may be interpreted to refer to a value that is $\pm 10\%$ of the numerical value.

One skilled in the art will readily realize that all ranges discussed can and do necessarily also describe all subranges therein for all purposes, and that all such subranges also form 15 part and parcel of this invention. Any listed range can be easily recognized as sufficiently describing and enabling the same range being broken down into at least equal halves, thirds, quarters, fifths, tenths, etc. As a non-limiting example, each range discussed herein can be readily broken down into 20 a lower third, middle third, and upper third, etc.

While some embodiments have been illustrated and described, it should be understood that changes and modifications can be made therein in accordance with ordinary skill in the art without departing from the invention in its broader aspects as defined in the following claims.

We claim:

1. A method of applying a nanocrystalline diamond film to a cutting tool, the cutting tool comprising tungsten carbide and having a cutting edge with a radius of curvature of no more than about 1 µm, the method comprising:

- (a) seeding a cutting surface of the cutting tool with a diamond nanopowder, the cutting surface having a reduced cobalt content; and
- (b) depositing a nanocrystalline diamond film having a thickness of no more than about 1 µm onto the seeded cutting surface.

2. The method of claim 1, further comprising chemically etching the cutting surface to provide the cutting surface having a reduced cobalt content prior to seeding.

3. The method of claim 2, wherein the cobalt content of the cutting surface is at least 28.5 percent lower than that of the underlying tungsten carbide substrate, based on atomic percent.

4. The method of claim 3, wherein the cobalt content of the cutting surface having a reduced cobalt content corresponds to a cobalt content achieved by dipping the cutting tool with a solution of 50% HF, HNO, and deionized water in a volume ratio of 1:2:2 for a period of 3 to 10 seconds.

5. The method of claim 2, wherein the cobalt content of the cutting surface having a reduced cobalt content corresponds to a cobalt content achieved by dipping the cutting tool with a solution of 50% HF, HNO3 and deionized water in a volume ratio of 1:2:2 for a period of 3 to 10 seconds.

6. The method of claim 1, wherein the cutting surface is

7. The method of claim 6, wherein the tungsten film has a thickness of about 30 to 250 nm.

8. The method of claim 1, wherein the deposited nanocrystalline diamond film has a hydrogen-terminated surface and is free of graphitic soot.

9. The method of claim 1, wherein depositing the nanocrystalline diamond film comprises depositing the nanocrystalline diamond film in a hot filament chemical vapor deposition apparatus.

10. The method of claim 1, wherein seeding the cutting surface comprises sonicating the cutting surface in a solution comprising a diamond nanopowder.

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11. The method of claim **1**, wherein the nanocrystalline diamond film is a continuous film.

12. A method of applying a nanocrystalline diamond film to a cutting tool, the cutting tool comprising tungsten carbide and having a cutting edge with a radius of curvature of no more than about 1 µm, the method comprising:

- (a) implanting carbon ions into a cutting surface of the cutting tool to provide a carbide rich cutting surface; and
- (b) depositing a nanocrystalline diamond film having a 10 thickness of no more than about 1 μ m onto the carbiderich cutting surface.

13. The method of claim **12**, further comprising chemically etching the cutting surface to provide a cutting surface having a reduced cobalt content.

14. The method of claim 12, wherein the deposited nanocrystalline diamond film has a hydrogen-terminated surface and is free of graphitic soot.

15. The method of claim 12, wherein depositing the nanocrystalline diamond film comprises depositing the nanocrystalline diamond film in a hot filament chemical vapor deposition apparatus.

16. The method of claim 15, wherein the nanocrystalline diamond film has an sp3-bonded content of at least about 95%.

17. The method of claim 12, wherein implanting carbon ions into the cutting surface is accomplished with a biasenhanced nucleation process.

18. The method of claim **12**, wherein the nanocrystalline diamond film is a continuous film.

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